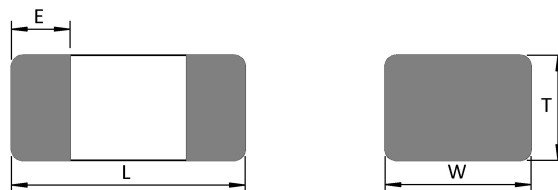
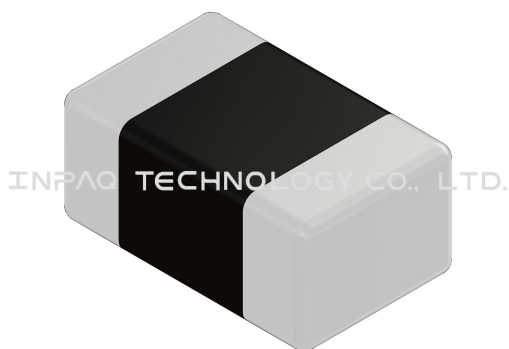


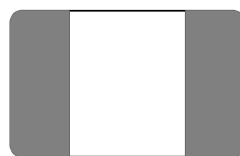
MCB2012H222EZP



Appearance & Shape



INPAQ TECHNOLOGY CO., LTD.



L	2.00±0.20
W	1.25±0.20
T	0.90±0.20
E	0.50±0.30

(unit:mm)

注意 NOTICE: All Specifications are subject to change without notice.

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2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Specification

L size(mm)	2.0±0.20
W size(mm)	1.2±0.20
T size(mm)	0.9±0.20
Size code Inch(mm)	0805(2012)
Impedance(Ω)	2200
Tolerance(%)	±25
Test Frequency(MHz)	100
DCR(Ω) Max.	0.6
I _{rms} (mA) @85°C (Max.)	200
Operating Temperature range(including self-temperature rising) °C	-55~+125

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Notices

- Monolithic inorganic material construction
- Closed magnetic circuit avoids crosstalk
- SMD Type & suitable for reflow and wave soldering
- Available in various sizes
- Excellent solderability and heat resistance
- High reliability
- With a sharp and frequency frequency impedance characteristics which can effectively filter high frequency noise without attenuating high frequency signal.
- Compliant with AEC Q200

Packing

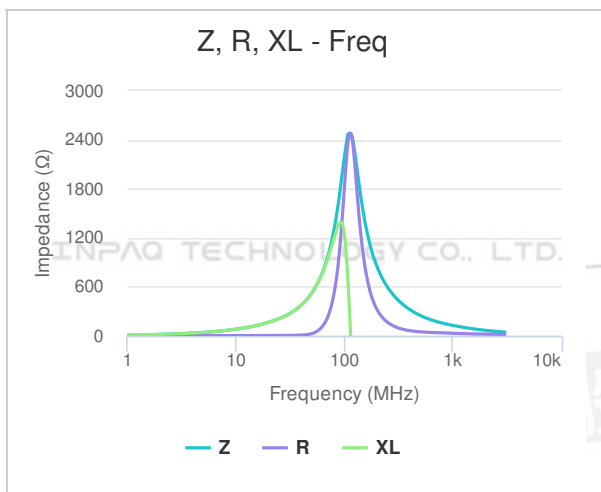
Packing Reel(Inch)	Packaging type	Standard package quantity(PCS)	Piece weight(gram)	MSL Level
7	Paper type	4000	0.0097	1

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Characteristic curve



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